In the United States Patent & Trademark Office

In re Application of:

IZUMI, , Kazuki et al.

Serial No.: 10/800,025

Title:

Titanium Copper With Excellent

Electroconductivity and Its Manufacturing Method

Filed:

March 15, 2004

Atty Dkt. No.:

03520.104

Facsimile Cover Page

Total Transmission: 3 pages including this sheet (703) 308-7751

Mr. Rick Haydn

Office of Initial Patent Examination United States Patent and Trademark Office Box 1450 Alexandria, VA 22313-1450

Dear Mr. Haydn:

Further to our telephone discussion this morning, enclosed herewith for appropriate action is a revised "Transmittal Letter" for the above-indicated New Non-Provisional Patent Application. I have amended the original letter to include the serial number, filing date, and Customer Identification Number. We would greatly appreciate your withdrawing the Abandonment of the above-described application.

In the event that any fees are required to accomplish such action, please debit Deposit Account 50-0548. Please contact me if any further action is required. Thank you very much for your assistance.

Date: 07 July 2005

Liniak, Berenato & White, LLC 6550 Rock Spring Drive, Suite 240

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Respectfully Submitted,

Reg. No. 32,680

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Transmittal Letter

Honorable Commissioner for Patents Box 1450 United States Patent and Trademark Office Alexandria, VA 22313-1450

Dear Sir:

Enclosed herewith for appropriate action is a new Non-Provisional Patent Application of Applicants:

Chihiro IZUMI:

c/o Nikko Metal Manufacturing Co., Ltd.

Kurami Work

Kurami 3, Samukawa-machi, Kouza-gun,

Kanagawa, JAPAN

And

Takaaki HATANO:

c/o Nikko Metal Manufacturing Co., Ltd.

Kurami Work

Kurami 3, Samukawa-machi, Kouza-gun,

Kanagawa, JAPAN

Entitled:

Titanium Copper With Excellent Electroconductivity and Its

Manufacturing Method

The Application consists of nine (9) total pages of Specification.

The Application claims priority to Japanese Patent Appln. Ser. No. 2003-0787521 filed on 20 March 2003.

The Application is being filed in Japanese, and without fee or Declaration.

New Non-Provisional Application Transmittal

U.S. Patent Appln. Serial No: To be assigned Inventors: Izumi et al.

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Please direct all correspondence for this application to

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Date: [Originally Submitted 15 March 2004]

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Respectfully Submitted,

deffrey I. Auerbach Reg. No. 32,680